

Low Power +3V to +5.5V, 1000kbps RS232 Transceivers

Features

- Meets EIA/TIA-232F and CCITT V.28/V.24 specifications for V_{CC} at +3.3V ±10% and +5V ±10%
- Low Quiescent Current: 0.5mA typ., 1mA max.
- Low Shutdown Current (where applicable): 1μA typical, 10μA max.
- Guaranteed High Data Rate 1000kbps
- Proprietary Switch-Capacitor Regulated Voltage Converters (patent pending)
- Proprietary AUTOGREEN Power Saving (patent pending)
- · Latch-up Free
- ESD Protection for RS-232 I/O's
 - ±15kV Human Body Model (HBM)
 - ±15kV EN61000-4-2 Air Gap Discharge
 - ±8kV EN61000-4-2 Contact Discharge
- Drop-in Replacements for MAX3220E, SP3220E, MAX3221E, ICL3221E, MAX3222E, ICL3222E, SP3222EU, MAX3223E, ICL3223E, SP3223EU, MAX3232E, ICL3232E, SP3232EU, LT1385 and SP385E
- Standard Data Rate at 250kbps Available on ZT32xxE Series

General Description

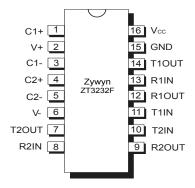


The ZT32xxF series devices are 3V powered EIA/TIA-232 and V.28/V.24 communication interfaces with low power requirements. They consist of two line drivers, two line receivers and the proprietary switch-capacitor regulated voltage converters. The ZT3220F has a 1Tx and 1Rx configuration. These devices operate from a single 3V to 5.5V power supply at the guaranteed data rate of 1000k bits/sec with enhanced electrostatic discharge (ESD) protection in all RS232 I/O pins exceeding ±15kV EN61000-4-2 Air Gap Discharge and ±8kV EN61000-4-2 Contact Discharge.

The ZT3221F and ZT3223F features the AUTOGREEN (patent pending) proprietary function which automatically powers down the on-chip regulated voltage converters and driver circuits when an RS-232 cable is disconnected from the host interface or when a connected peripheral device is turned off.

Applications

- Battery-Powered And Hand-Held Applications
- Notebooks, Subnotebooks, and Palmtops
- Industrial and Embedded PCs
- Data Cables for Cell Phones and PDAs
- Terminal Adapters and POS terminals
- · Peripherals interface
- · Routers and HUBs



Product Selection Guide

		RS232	RS232	Data Rate	15KV ESD	Receiver	SHUTDOWN	AUTOGREEN	Number	
Part Number	Power Supply	Drivers	Receivers	(kbps)	IEC1000 4-2	Enable	Enable	Function	of Pins	Package Type
ZT3220F	+3V to +5.5V	1	1	1000	RS232 I/O	YES	YES	NO	16	SSOP, TSSOP, WSOIC
ZT3221F	+3V to +5.5V	1	1	1000	RS232 I/O	YES	YES	YES	16	SSOP, TSSOP
ZT3222F	+3V to +5.5V	2	2	1000	RS232 I/O	YES	YES	NO	18, 20	18-WSOIC 20-SSOP, 20-TSSOP,
ZT3232F	+3V to +5.5V	2	2	1000	RS232 I/O	NO	NO	NO	16	NSOIC, WSOIC, SSOP, TSSOP, OFN
ZT3223F	+3V to +5.5V	2	2	1000	RS232 I/O	YES	YES	YES	20	SSOP, TSSOP
ZT1385F	+3V to +5.5V	2	2	1000	RS232 I/O	NO	YES	NO	18, 20	18-WSOIC, 20-SSOP



Absolute Maximum Ratings

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

Power Supply, (V _{CC})0.3V to +6.0V	/
V+0.3V to +7.0V	/
V-+0.3V to -7.0V	
V+ + V- +13.0V	/
I _{CC} (DC V _{CC} or GND current)±100mA	١
Input Voltages	
TxIN, GREEN, SHUTDOWN, EN0.3V to +6.0V	/
RxIN±25\	/
Output Voltages	
TxOUT±15V	/
RxOUT, <u>IDLE</u> –0.3V to (V _{CC} +0.3V))
Short-Circuit Duration	
TxOUTContinuous	S
Operating Temperature40°C to +85°C	_
Storage Temperature65°C to +150°C	_

Power Dissipation Per Package

16-pin SSOP (derate 7.20mW/°C above +70°C)584mW
16-pin nSOIC (derate 10.00mW/°C above +70°C)720mW
16-pin WSOIC (derate 10.10mW/°C above +70°C)787mW
16-pin TSSOP (derate 6.80mW/°C above +70°C)556mW
16-pin PDIP (derate 11.20mW/°C above +70°C)896mW
16-pin QFN (derate 24.00mW/°C above +70°C)2000mW
18-pin PDIP (derate 12.60mW/°C above +70°C)962mW
18-pin WSOIC (derate 11.10mW/°C above +70°C)850mW
20-pin PDIP (derate 12.80mW/°C above +70°C)976mW
20-pin SSOP (derate 8.10mW/°C above +70°C)647mW

Storage Considerations

Storage in a low humidity environment is preferred. Large high density plastic packages are moisture sensitive and should be stored in Dry Vapor Barrier Bags. Prior to usage, the parts should remain bagged and stored below 40°C and 60%RH. If the parts are removed from the bag, they should be used within 168 hours or stored in an environment at or below 20%RH. If the above conditions cannot be followed, the parts should be baked for 12 hours at 125°C in order to remove moisture prior to soldering. Zywyn ships product in Dry Vapor Barrier Bags with a humidity indicator card and desiccant pack. The humidity indicator should be below 30%RH. The MSL of this product is 3.

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Electrical Characteristics

Unless otherwise stated, $V_{CC} = +3.0 V$ to +5.0 V, $T_A = T_{min}$ to $T_{max'}$ C1 to C4 = $0.1 \mu F$, typical values apply at $V_{CC} = +3.3 V$ or +5.0 V and $T_A = 25 ^{\circ} C$.

Parameter	Condition	Min	Тур	Max	Units
TTL Logic Input TTL Logic Output RS-232 Input RS-232 Output Charge Pump Pin Power Pin	$T_1IN, T_2IN, \overline{GREEN}, \overline{SHUTDOWN}, \overline{EN}$ $R_1OUT, R_2OUT, \overline{IDLE}$ R_1IN, R_2IN T_1OUT, T_2OUT C_1P, C_1N, C_2P, C_2N $V_{CC}, V_{GND}, V_{DD}, V_{SS}$				
Charge Pump Caps Temp 0°C to +70°C Temp -40°C to +85°C V _{CC} Voltage Range	C_1P , C_1N , C_2P , C_2N Commercial Grade Industrial Grade $V_{CC} = +5.0V$ Supply $V_{CC} = +3.3V$ Supply	0.1 0 -40 4.5 3	0.1 +25 +25 5 3.3	1 +70 +85 5.5 3.6	μF ℃ ℃ V
Supply Current	TTL Inputs = V _{CC} /GND, RS-232 Input = float, V _{CC} = 3.3V (For ZT3220F, ZT3222F, ZT3232F and ZT1385F)		0.5	1	mA
Supply Current, AUTOGREEN Disabled	GREEN = V _{CC} , (For ZT3221F and ZT3223F); SHUTDOWN = V _{CC} , (For ZT3221F, ZT3222F, ZT1385F and ZT3223F), TTL Inputs = V _{CC} /GND, RS-232 Input = float, V _{CC} = 3.3V		0.5	1	mA
Supply Current, AUTOGREEN Enabled	$\overline{\text{GREEN}} = \text{GND, (For ZT3221F and ZT3223F); } \overline{\text{SHUTDOWN}} = V_{CC},$ (For ZT3221F, ZT3222F, ZT1385F and ZT3223F), $\overline{\text{TTL Inputs}} = V_{CC}/\overline{\text{GND, RS-232 Input}} = \text{float, V}_{CC} = 3.3V$		1	10	μΑ
Supply Current, SHUTDOWN Enabled	$\overline{\text{GREEN}} = \text{V}_{\text{CC}}/\text{GND}, \text{ (For ZT3221F and ZT3223F);}$ $\overline{\text{SHUTDOWN}} = \text{GND}, \text{ (For ZT3221F, ZT3222F, ZT1385F and ZT3223F),}$ $\overline{\text{TTL Inputs}} = \text{V}_{\text{CC}}/\text{GND}, \text{RS-232 Inputs} = \text{float, V}_{\text{CC}} = 3.3\text{V}$		1	10	μΑ
TTL LOGIC Input Input Threshold Low Input Threshold High Input Threshold High	$V_{CC} = +5.0V$ Supply $V_{CC} = +3.3V$ Supply	2.4 2		0.8	V V V
Input Hysteresis Input Leakage Current Input Leakage Current	$V_{IN} = V_{CC}$ and GND, TIN, \overline{EN} , \overline{GREEN} , $\overline{SHUTDOWN}$ $V_{IN} = V_{CC}$ and GND, TIN (For ZT1385F)		0.5 ±0.01 50	±1 200	V μΑ μΑ
Output Voltage Low Output Voltage High Output Leakage Current	I _{OUT} = 1.6mA I _{OUT} = -1.0mA Receiver Outputs Disabled, V _{OUT} = V _{CC} or GND, SHUTDOWN = GND, EN = V _{CC}	V _{CC} -0.6	V _{CC} -0.1 ±0.05	0.4 ±10	V V μΑ
Receiver Input Input Voltage Range Input Threshold Low Input Threshold High	$T_A = T_{min} - T_{max}$ $T_A = 25^{\circ}C, V_{CC} = 5.0V$ $T_A = 25^{\circ}C, V_{CC} = 3.3V$ $V = 25^{\circ}C$	-25 0.8 0.6	1.5 1.2	+25	V V V
Input Hysteresis Input Resistance	$T_A = 25$ °C $V_{IN} = \pm 25$ V, $T_A = 25$ °C	3	0.5	7	V kΩ
Transmitter Output Output Voltage Swing Output Resistance Output Short-Circuit Current Output Leakage Current	$R_L = 3k\Omega$, All Outputs are loaded $V_{CC} = V_{DD} = V_{SS} = GND$, $V_{OUT} = \pm 2V$ $V_{OUT} = GND$ Transmitter Disabled, $V_{OLIT} = \pm 12V$	±5 300	±5	±60	V Ω mA μA
Parameter Timing Characteristics	Condition	Min	Тур	Max	Units



$R_L = 3k\Omega$, $C_L = 250pF$, One Transmitter Switching, $T_A = 25^{\circ}C$	1,000			kbps
$R_L = 3 \sim 7 k\Omega$, $C_L = 150 pF$ to 250 pF, One Transmitter Switching, $T_A = 25 ^{\circ} C$, Measured from +3V to -3V or -3V to +3V		60		V/µs
$C_L = 150 pF$ $C_L = 150 pF$ $t_{PHL} - t_{PLH}$ For ZT3220F, ZT3221F, ZT3222F, ZT3223F only For ZT3220F, ZT3221F, ZT3222F, ZT3223F only		0.15 0.15 50 0.2 0.2		μs μs ns μs μs
For ZT3221F and ZT3223F only For ZT3221F and ZT3223F only For ZT3221F and ZT3223F only		1 30 100		μs μs μs
RS-232 Inputs and Outputs RS-232 Inputs and Outputs RS-232 Inputs and Outputs		±15 ±8 ±15		kV kV kV
	$R_L=3\sim 7k\Omega, C_L=150 pF \ to \ 250 pF, One Transmitter Switching, \\ T_A=25°C, Measured from +3V \ to -3V \ or -3V \ to +3V \\ C_L=150 pF \\ C_L=150 pF \\ t_{PHL}-t_{PLH} \\ For \ ZT3220F, \ ZT3221F, \ ZT3222F, \ ZT3223F \ only \\ For \ ZT3220F, \ ZT3221F, \ ZT3222F, \ ZT3223F \ only \\ For \ ZT3221F \ and \ ZT3223F \ only \\ For \ ZT3221F \ and \ ZT3223F \ only \\ For \ ZT3221F \ and \ ZT3223F \ only \\ RS-232 \ lnputs \ and \ Outputs \\ RS-232 \ lnputs \ and \ RS-232 \ lnputs \ and \ Outputs \\ RS-232 \ lnputs \ and \ RS-232 \ lnputs \ RS-232 \ lnputs \ and \ RS-232 \ lnputs \ and \ RS-232 \ lnputs \ and \ RS-232 \ lnputs \ and$	$R_L=3\sim 7k\Omega, C_L=150 \text{pF to } 250 \text{pF, One Transmitter Switching,} \\ T_A=25^{\circ}\text{C, Measured from } +3\text{V to } -3\text{V or } -3\text{V to } +3\text{V} \\ C_L=150 \text{pF} \\ C_L=150 \text{pF} \\ t_{\text{PHL}}-t_{\text{PLH}} \\ \text{For ZT3220F, ZT3221F, ZT3222F, ZT3223F only} \\ \text{For ZT3220F, ZT3221F, ZT3222F, ZT3223F only} \\ \text{For ZT3221F and ZT3223F only} \\ \text{For ZT3221F and ZT3223F only} \\ \text{For ZT3221F and ZT3223F only} \\ \text{RS-232 Inputs and Outputs} \\ $	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$

Product Cross Reference

	Pin-to-Pin	Pin-to-Pin	Pin-to-Pin	Pin-to-Pin	Pin-to-Pin
Part Number	Cross MAXIM	Cross Intersil	Cross TI	Cross ST-M	Cross EXAR
ZT3220F	n/a	n/a	SNx5C3220	n/a	SP3220U
ZT3221F	n/a	n/a	SNx5C3221	n/a	n/a
ZT3222F	n/a	n/a	SNx5C3222	n/a	SP3222U
ZT3232F	n/a	n/a	SNx5C3232	n/a	SP3232U
ZT3223F	MAX3225E	l n/a	SNx5C3223	n/a	SP3223U



Pin Description

			n Number					Name	Description
ZT3220F	ZT3221F	ZT322	22F	ZT3232F	ZT13	385F	ZT3223F		
16 Pins	16 Pins	18 Pins	20 Pins	16 Pins	18 Pins	20 Pins	20 Pins		
1	1	1	1	-	-	-	1	EN.	Receiver Enable. Logic low for Normal operation. Logic high to force the receiver outputs into high impedance state
2	2	2	2	1	2	2	2	C1+	Positive terminal of the boostrapped voltage switch capacitor
3	3	3	3	2	3	3	3	V+	Regulated +5.4V output generated by the voltage converter
4	4	4	4	3	4	4	4	C1-	Negative terminal of the boostrapped voltage switch capacitor
5	5	5	5	4	5	5	5	C2+	Positive terminal of the inverted voltage switch capacitor
7	7	7	7	6	7	7	7	V-	Regulated –5.7V output generated by the voltage converter
6 d	6	6	6	5	6	6	6	C2-	Negative terminal of the invert- voltage switch capacitor
8	8	14	16	13	14	16	16	R1 IN	First RS232 receiver input
-	-	9	9	8	9	9	9	R2 IN	Second RS232 receiver input
9	9	13	15	12	13	15	15	R1 OUT	First TTL/CMOS receiver output
-	-	10	10	9	10	12	10	R2 OUT	Second TTL/CMOS receiver output
11	11	12	13	11	12	14	13	T1 IN	First TTL/CMOS transmitter input
-	-	11	12	10	11	13	12	T2 IN	Second TTL/CMOS transmitter input
13	13	15	17	14	15	17	17	T1 OUT	First RS232 transmitter output
-	-	8	8	7	8	8	8	T2 OUT	Second RS232 transmitter output
-	10	-	_	-	-	-	11	ĪDLĒ	TTL/CMOS output indicating AUTOGREEN or SHUTDOWN status
16	16	18	20	I	18	20	20	SHUTDOWN	Shutdown control. A logic LOW to disable drivers and voltage converter
-	12	_	1	-	-	-	14	GREEN	A logic HIGH to override AUTO- GREEN circuitry keeping transmitters ON. (SHUTDOWN must be HIGH)
14	14	16	18	15	16	18	18	GND	Ground
15	15	17	19	16	17	19	19	V _{CC}	+3V to +5.5V Supply Voltage
10, 12	-	-	11, 14	-	1	1, 10, 11	-	NC	No connect



Pin Description

ZT3232LFEQ (5x5 16-QFN Package)

1	C1-	
2	C1-	Negative terminal of the boostrapped voltage switch capacitor
2	C2+	Positive terminal of the inverted voltage switch capacitor
3	C2-	Negative terminal of the boostrapped voltage switch capacitor.
4	V-	Regulated –5.7V output generated by the voltage converter
5	T2OUT	Second RS232 transmitter output
6	R2IN	Second RS232 receiver input.
7	R2OUT	Second TTL/CMOS receiver output.
8	T2IN	Second TTL/CMOS transmitter input.
9	T1IN	First TTL/CMOS transmitter input
10	R10UT	First TTL/CMOS receiver output.
11	R1IN	First RS232 receiver input.
12	T1OUT	First RS232 transmitter output
13	GND	Ground.
14	VCC	+3V to +5.5V Supply Voltage
15	C1+	Positive terminal of the boostrapped voltage switch capacitor
16	V+	Regulated +5.4V output generated by the voltage onverter



Circuit Description

Proprietary Switch-Capacitor Regulated Voltage Converter

Different from other suppliers, Zywyn uses a patent pending switch-capacitor voltage-controlled source and sink current generators design to provide powerful bipolar voltages to maintain compliant EIA/RS232 levels regardless of power supply fluctuations. The design consists of an internal regulated oscillator, a two phase clock cycling, regulated complementary MOS switches, fast switching diode and switch capacitors.

The switch capacitor bi-directional current generators operate with Zywyn's proprietary smartly regulated complementary MOS switches and fast switching diode from its proprietary high voltage process technology. The efficiency of these bi-directional current generators is well over 70%. The switching frequency is generated by an internal oscillator and regulated by the current loads. The switch capacitor pump design delivers higher negative bucked voltage than the positive boosted voltage to achieve a balanced voltage controlled source and sink current generators resulting a balanced bipolar voltage supplies to the chip.

With its unique proprietary design technique, Zywyn's interface product series provide a better power efficient, stable and compliant EIA/RS232 levels with superior low power consumption.

Controlled Power-Down

The ZT3220F, ZT3221F, ZT3222F and ZT3223F have a low-power shutdown mode controlled by the SHUTDOWN pin. During shutdown the driver output and the switch-capacitor regulated voltage converter are disabled with the supply current falls to less than $1\mu A$.

The ZT3221F and ZT3223F use Zywyn's patent pending AUTOGREEN circuitry to set/reset latches, which enable the circuit shutdown function when a RS232 cable is disconnected or when the peripheral is turned off and reduce the power supply drain to a 1µA supply current. Otherwise, when a RS232 cable is connected or when the peripheral is turned on, the devices will automatically become active again.

ESD Immunity

Electro-Static Discharge (ESD) is an important factor when implementing a serial port into a system. In some applications, it is crucial that the ESD protection for the system must meet a certain tolerance level. Since RS232 transceiver devices are exposed to the outside world, there are many environmental factors that can effect the serial port and even subject it to transients that could potentially damage the transceiver itself.

The RS232 transceiver is usually routed from the serial port connector to the transceiver IC through the metal trace on the printed circuit board. This trace will have some small amount of resistance that will add some protection in terms of limiting transient current to the IC. However for added voltage protection, transient voltage suppressors (TVS) or transzorbs, which are back-to-back diode arrays clamp, are usually necessary to

protect the serial port circuity.

To further reduce cost within their system, more engineers are requiring higher ESD tolerances from the transceiver ICs themselves without having to add costly TVS circuitry. Zywyn's RS232 transceivers includes built-in transient voltage suppression where external ESD circuitry is not necessary to meet the MIL-STD-883, Method 3015, Human Body Model and the EN61000-4-2 Air/Contact Discharge tests.

The Human Body Model has been the generally accepted ESD testing method for semiconductors. This test is intended to simulate the human body's potential to store electrostatic energy and discharge it to an integrated circuit upon close proximity or contact. This method will test the IC's capability to withstand an ESD transient during normal handling such as in manufacturing areas where the ICs tend to be handled frequently.

EN61000-4-2 is used for testing ESD on equipment and systems. For system manufacturers, they must guarantee a certain amount of ESD protection since the system itself is exposed to the outside environment and human presence. EN61000-4-2 specifies that the system is required to withstand an amount of static electricity when ESD is applied to exposed metal points and surfaces of the equipment that are accessible to personnel during normal usage. The transceiver IC receives most of the ESD current when the ESD source is applied to the connector pins.

There are two methods within EN61000-4-2, the Air Discharge method and the Contact Discharge method. With the Air Discharge Method, an ESD voltage is applied to the equipment under test through air, which simulates an electrically charged person ready to connect a cable onto the rear of the system and the high energy potential on the person discharges through an arcing path to the rear panel of the system before he or she even touches the system. The Contact Discharge Method applies the ESD current directly to the EUT. This method was devised to reduce the unpredictability of the ESD arc. The discharge current rise time is constant since the energy is directly transferred without the air-gap arc inconsistencies.

Zywyn's RS232 transceivers meets and exceeds the minimum criteria for EN61000-4-2 with \pm 15kV for Air Gap Discharge and \pm 8kV for Contact Discharge.



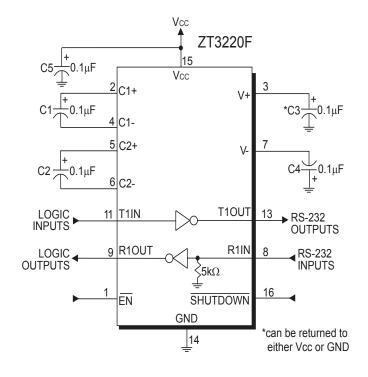
Operation Status	GREEN	SHUTDOWN	EN	Signal at R _X IN	IDLE	T _X OUT	R _X OUT
Shutdown	don't care	0	0	present	1	tri-state	active
	don't care	0	0	not present	0	tri-state	active
	don't' care	0	1	present	1	tri-state	tri-state
	don't' care	0	1	not present	0	tri-state	tri-state
Normal without GREEN	1	1	0	present	1	active	active
	1	1	0	not present	0	active	active
	1	1	1	present	1	active	tri-state
	1	1	1	not present	0	active	tri-state
Normal with GREEN	0	1	0	present	1	active	active
	0	1	0	not present	0	tri-state	tri-state
	0	1	1	present	1	active	tri-state
	0	1	1	not present	0	tri-state	tri-state

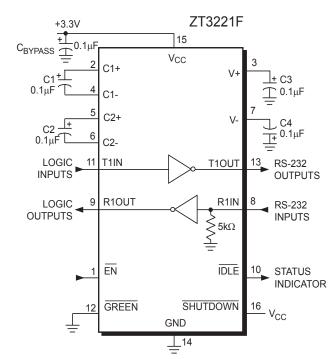
Table 1. ZT32xxF Truth Table



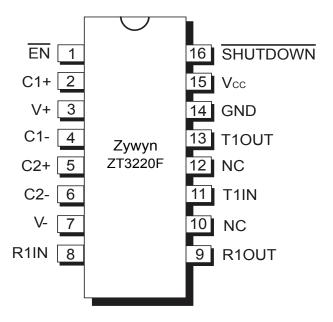
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Typical Application Circuits

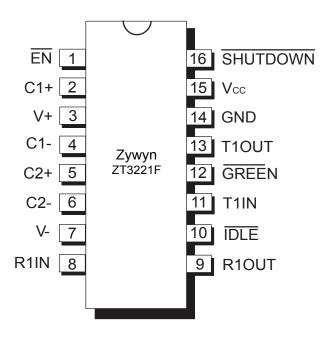




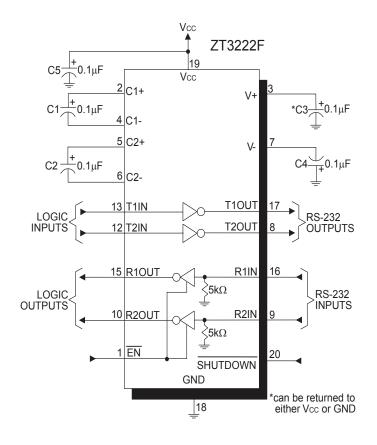
16-pin SSOP/TSSOP/WSOIC

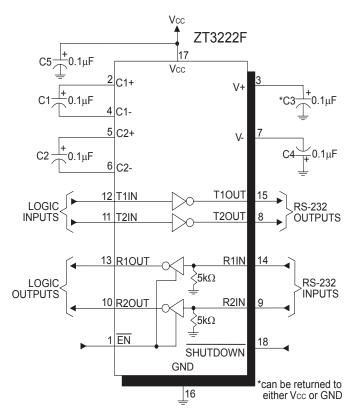


16-pin SSOP/TSSOP

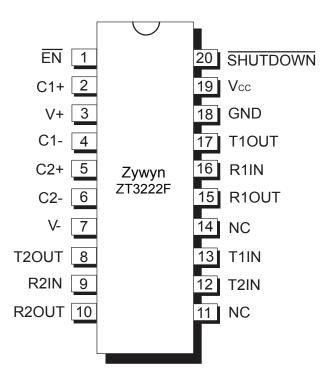


Typical Application Circuits



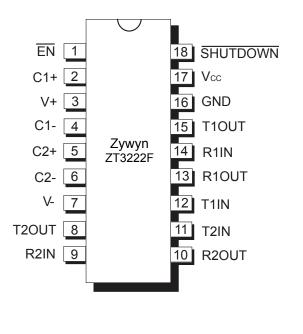


20-Pin SSOP/TSSOP

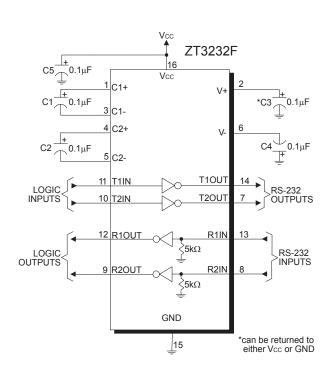


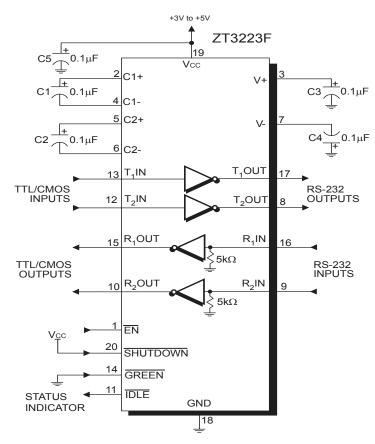
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18-Pin PDIP/WSOIC

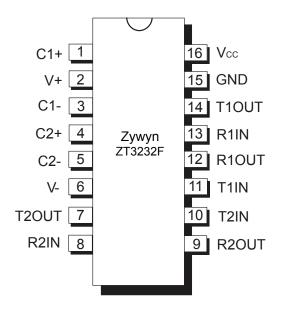


Typical Application Circuits

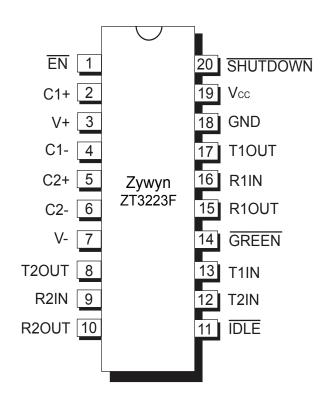




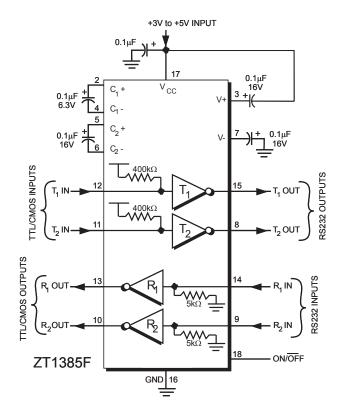
16-Pin PDIP/SSOP/SOIC/TSSOP/WSOIC



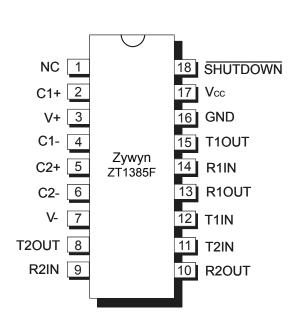
20-Pin PDIP/SSOP/TSSOP

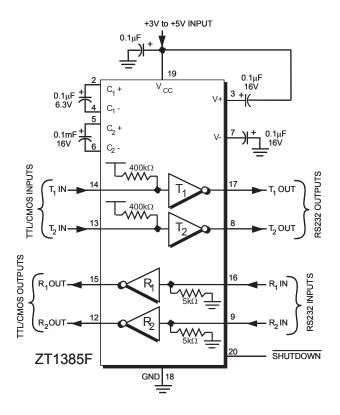


Typical Application Circuits

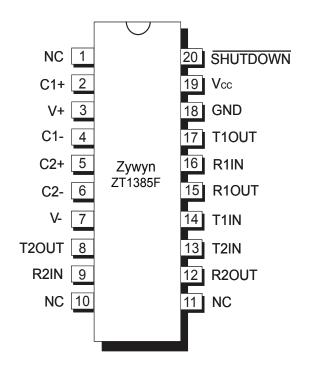


18-pin WSOIC



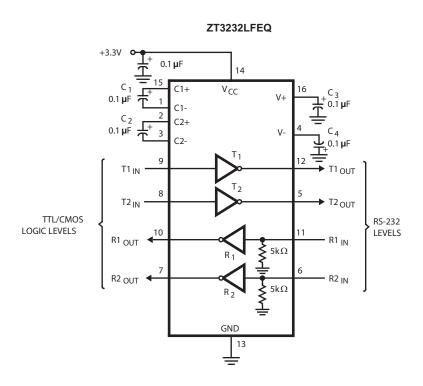


20-pin SSOP

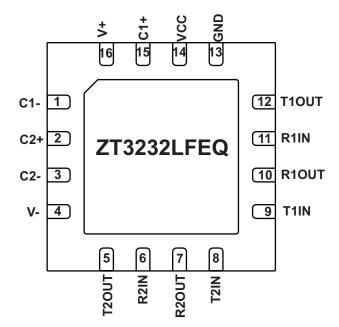




Typical Application Circuits

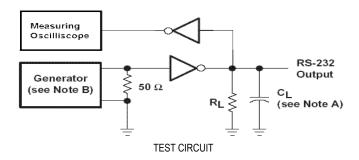


16-pin QFN





Typical Test Circuits



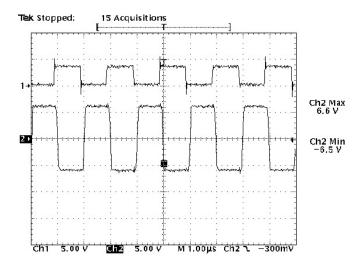


Figure 1. ZT32xxF TxIN to TxOut (no load) at 1Mbps waveform

RS232 Signal Characteristics

Figure 1 shows the normal RS232 transceiver function with a TTL/CMOS signal applied to the input on channel 1 and the resultant RS232 output shown on channel 2. This figure shows a typical RS232 line driver output without loading. In other words, this is the open circuit RS232 output voltage. The charge pump voltage converter efficiently converts the necessary voltage for the driver's output transistors so that the RS232 output is close to the ideal rail voltage of 6.6V.

Figure 2 shows the RS232 transceiver function using the TTL/CMOS input on channel 1 while showing the RS232 output on channel 2. This figure shows the RS232 signal while the output is loaded with 3kohms and 250pF. The resistive load is the receiver's input impedance as the driver's output is looped back to the receiver's input. The resultant output on channel 3

Maximum Data Rate Test Circuit

Notes:

A. $R_I = 3k\Omega$, $C_I = 250pF$, $T_A = 25^{\circ}C$,

One Driver Switching

B. The pulse generator had the following characteristics:

PRR = 1000 kbps, Zo = 50Ω , 50% duty cycle,

 $T_r \& T_f \le 10 ns$.

C. $\overline{SHUTDOWN} = V_{CC}$ when applicable.

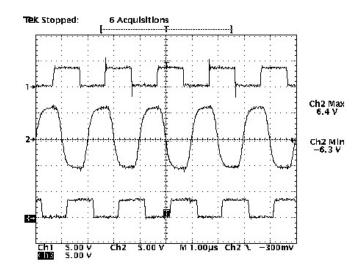
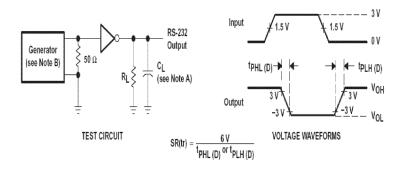


Figure 2. ZT32xxF TxIN to TxOut to RxOut (loopback to Rx with 250pF load) at 1Mbps waveform

is the receiver's TTL/CMOS output. While loaded with a typical RS232 load, the driver's output level only drops 0.2V from its open circuit voltage while running at 1Mbps. The RS-232 output on channel 2 also shows good signal integrity while at the high data rates, which allows the receiver to process the signal will minimum skew and delay. Zywyn's low-drop driver circuitry working with its efficient voltage regulator allows superior line driving capability with the bonus of ± 15 kV ESD immunity.

rev. 06

Typical Test Circuits



Driver Transition-Region Slew Rate Test Circuit

Notes:

A. $\rm R_L$ = 3k~7k Ω , $\rm C_L$ = 150pF to 250pF,

One Driver Switching, $T_A = 25^{\circ}C$,

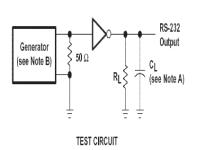
Measured from +3V to -3V or -3V to +3V.

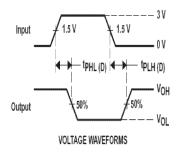
B. The pulse generator had the following characteristics:

PRR = 1000 kbps, Zo = 50Ω , 50% duty cycle,

 $T_r \& T_f \le 10$ ns.

C. $\overline{SHUTDOWN} = V_{CC}$ when applicable.





Driver Propagation (t_{PHL} & t_{PLH}) Test Circuit Notes:

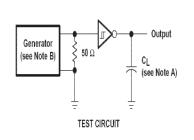
A. All drivers loaded with R_L = $3k\Omega$, C_L = 1000pF.

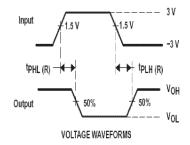
B. The pulse generator had the following characteristics:

PRR = 1000 kbps, Zo = 50Ω , 50% duty cycle,

 $T_r \& T_f \le 10$ ns.

C. $\overline{\text{SHUTDOWN}} = V_{CC}$ when applicable.





Receiver Propagation Delay Times Test Circuit

Notes:

A. $C_1 = 150 pF$, including probe and jig capacitance.

B. The pulse generator had the following characteristics:

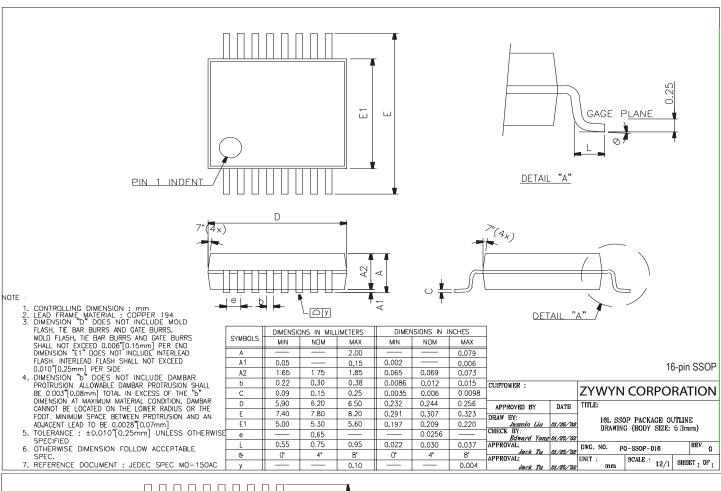
PRR = 1000 kbps, Zo = 50Ω , 50% duty cycle,

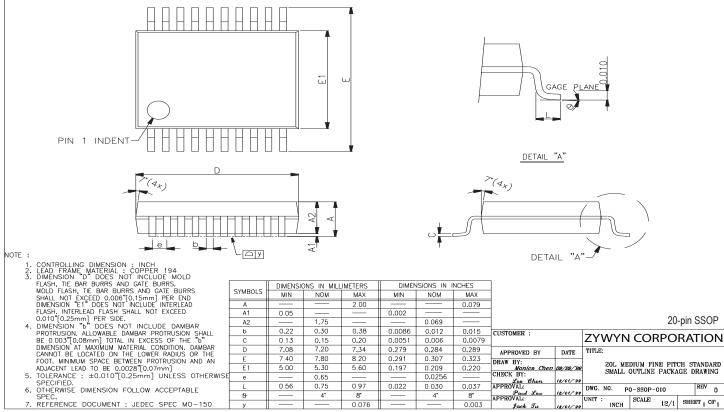
 $T_r \& T_f \le 10 ns$.

C. $\overline{SHUTDOWN} = V_{CC}$ when applicable.

15

Package Information

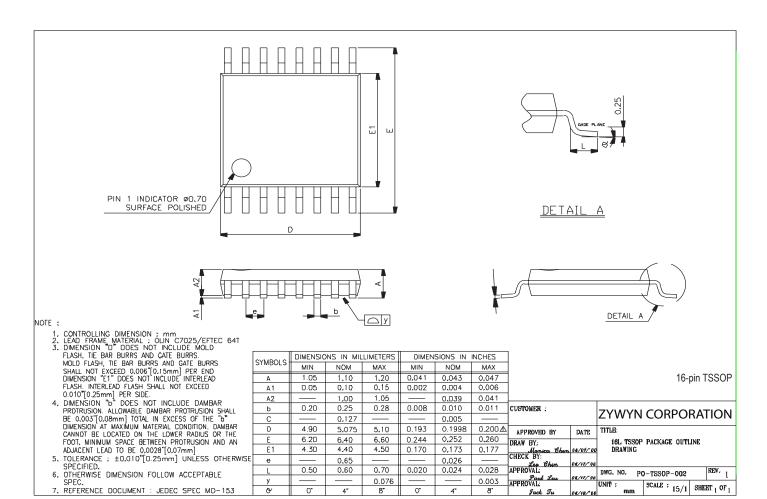


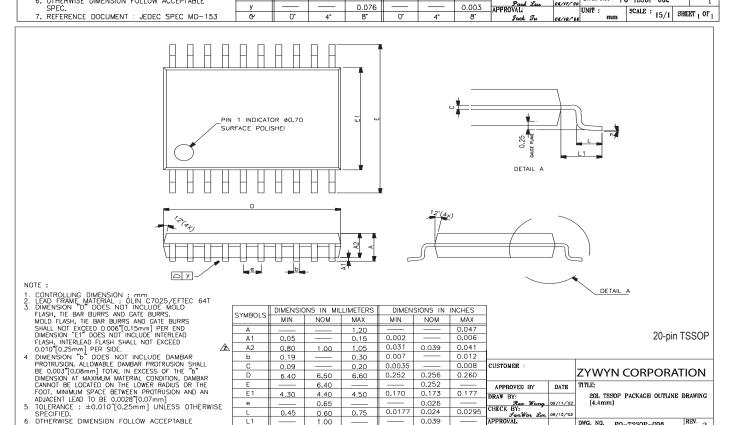




Specifications subject to change without notice

Zywyn Corporation





SPECIFIED.

THERWISE DIMENSION FOLLOW ACCEPTABLE
SPEC.

REFERENCE DOCUMENT : JEDEC SPEC MO-153

PO-TSSOP-008

Specifications subject to change without notice

mm SCALE : 15/1 SHEET 1 OF 1

ZT32xxF

0.75

0.076

8,

0.65

0.60 1.00

0.45

0.026

0.0177

CHECK BY FanWin Lin

Parker APPROVAL:

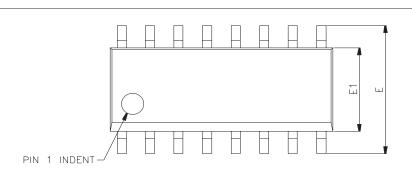
09/13/02

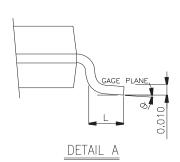
09/13/02

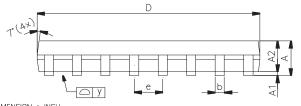
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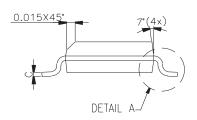
0.0295

0,003









NOTE:

- CONTROLLING DIMENSION: INCH
 LEAD FRAME MATERIAL: COPPER 194
 DIMENSION "D" DOES NOT INCLUDE MOLD
 FLASH, TIE BAR BURRS AND CATE BURRS
 MOLD FLASH, TIE BAR BURRS AND CATE BURRS
 SHALL NOT EXCEED 0.006*[0.15mm] PER END
 DIMENSION "E" DOES NOT INCLUDE INTERLEAD
 FLASH, INTERLEAD FLASH SHALL NOT EXCEED
 0.010*[0.25mm] PER SIDE.
 DIMENSION "B" DOES NOT INCLUDE DAMBAR
 PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL
 BE 0.003*[0.08mm] IOTAL IN EXCESS OF THE "B"
 DIMENSION AT MAXIMUM MATERIAL CONDITION, DAMBAR
 CANNOT BE LOCATED ON THE LOWER RADIUS OR THE
 FOOT, MINIMUM SPACE BETWEEN PROTRUSION AND AN
 ADJACENT LEAD TO BE 0.00028*[0.07mm]
 TOLFRANCE: ±0.010*[0.25mm] UNLESS OTHERWISE
 SPECIFIED.
- SPECIFIED,

 6. OTHERWISE DIMENSION FOLLOW ACCEPTABLE
- 7. REFERENCE DOCUMENT : JEDEC SPEC MS-012

	DIMENSIO	NS IN MILL	IMETERS	DIMENSIONS IN INCHES			
SYMBOLS	MIN	NOM	MAX	MIN	NOM	MAX	
A	1.47	1,60	1,73	0.058	0.063	0.068	
A1	0.10		0.25	0,004		0,010	
A2		1.45			0.057		
Ь	0.33	0.41	0,51	0.013	0.016	0,020	
С	0.19	0.20	0.25	0.0075	0.008	0.0098	

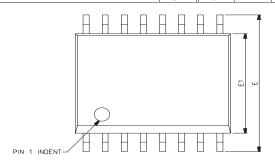
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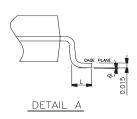
9,80 9,91 10,01 0.386 0.390 0.394 D 5.79 6,20 0,228 0,236 0,244 E1 3.81 3,91 3.99 0.150 0.154 0.157 1,27 0.050 е 1.27 0.3B 0.71 0.015 0.028 0.050 0.076 0.003

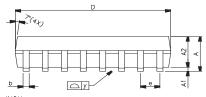
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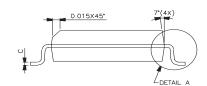
16-pin nSOIC

arrame veno								
CUSTOMER:		ZYWYN CORPORATION						
		Z 1 VV 1 1 V	ZIWIN COM ONAHON					
APPROVED BY	DATE	TITLE:						
DRAW BY:		16L SMALL OUTLINE PACKAGE						
Monica Chen	11/09/99"	DRAWIN	IG(0.150")					
CHECK BY:			(01100 /					
Leo Chan	11/10/99							
APPROVAL		DWG. NO. PO-	SOP-003	REV. 0				
APPROVAL	11/10/99	* 11 17 m						
		UNIT :	SCALE : 12/1	SHEET OF				
Jack Tu	11/11/99	INCH	12/1					









NOTE :

- 1. CONTROLLING DIMENSION : INCH
 2. LEAD FRAME MATERIAL : COPPER 194
 3. DIMENSION "O DOES NOT INCLUDE MOLD
 FLASH, TIE BAR BURRS AND CATE BURRS.
 MOLD FLASH, TIE BAR BURRS AND CATE BURRS.
 MOLD FLASH, TIE BAR BURRS AND CATE BURRS
 SHALL NOT EXCEED 0.006"[0.15mm] PER END
 DIMENSION "E" DOES NOT INCLUDE INTERLEAD
 FLASH, INTERLEAD FLASH SHALL NOT EXCEED
 0.010"[0.25mm] PER SIDE.
 4. DIMENSION "D" DOES NOT INCLUDE DAMBAR
 PROTRUSION, ALLOWABLE DAMBAR PROTRUSION SHALL
 BE 0.003"[0.08mm] TOTAL IN EXCESS OF THE "b"
 DIMENSION AT MAXIMUM MATERIAL CONDITION, DAMBAR
 CANNOT BE LOCATED ON THE LOWER RADIUS OR THE
 FOOT, MINIMUM SPACE BETWEEN PROTRUSION AND AN
 ADJACENT LEAD TO BE 0.0028"[0.07mm]
 5. TOLERANCE : ±0.010"[0.25mm] UNLESS OTHERWISE
 SPECIFIED.
 6. OTHERWISE DIMENSION FOLLOW ACCEPTABLE
 SPEC.
 7. REFERENCE DOCUMENT : JEDEC SPEC MS-013
- REFERENCE DOCUMENT : JEDEC SPEC MS-013

	SYMBOLS	DIMENSIO	DNS IN MIL	LIMETERS	DIMEN	SIONS IN	INCHES	
	STMBULS	MIN	NOM	MAX	MIN	NOM	MAX	
	Α	2.36	2,49	2.64	0.093	0,098	0.104	1
	A1	0.10		0.30	0.004		0.012]
	A2		2.31			0.091		L
	b	0.33	0.41	0.51	0.013	0.016	0.020	ζcι
	С	0.18	0.23	0.28	0.007	0.009	0.011	1
	D	10,08	10,31	10.49	0,397	0.406	0.413	Т
	E	10,01	10,31	10,64	0,394	0,406	0,419	DF
	E1	7.39	7.49	7.59	0,291	0,295	0,299	0.

1,27

0,076

18

0.015

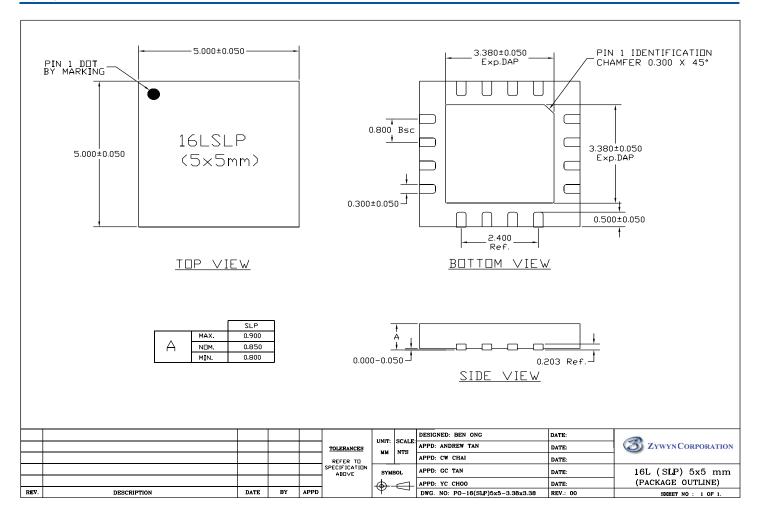
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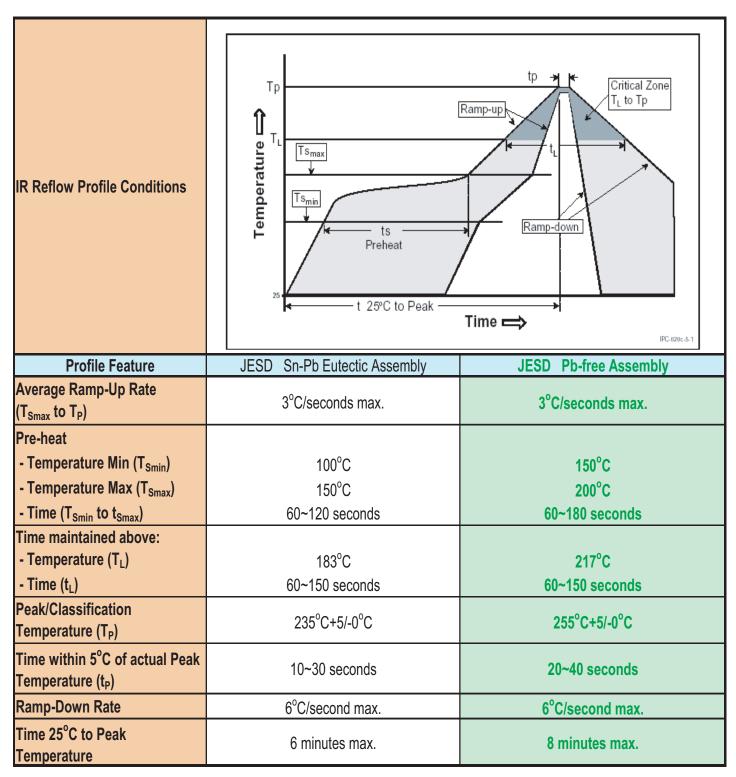
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U.1U4				10-01	n wSOIC	
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0.020	CUSTOMER :		7V\\/V\I	CORPO	DATION	
0.011			Z I VV I IN	CORFO	NATION	
0.413	APPROVED BY	DATE	TITLE:			
0,419	DRAW HY:		16L WIDE I	BODY SMALL OU	TLINE	
0,299	Monica Chen	10/28/99	PACKAGE I	DRAWING		
	CHECK BY:	11/01/99				
0.050	APPROVAL:		DWG. NO. PO	0-SOP-004	REV. 0	
	APPROVAL:	11/02/- 09	UNIT :	SCALE : n //		
8,	Fack Tu	11/02/98		SCALE: 8/1	SHEET 1 OF 1	
Specifications subject to change without notice						

Dec 2013





Green Package SMD IR Reflow Profile Information



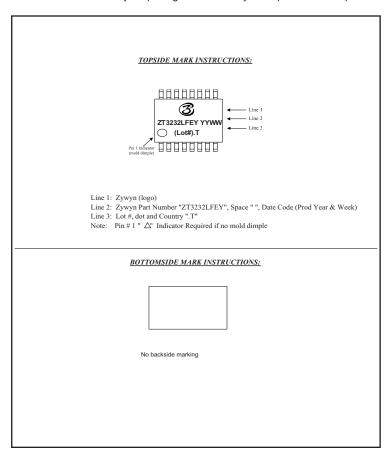
Zywyn Green Packages are Pb-free and RoHS compliance.



Ordering Information

Part Number	Temperature Range	Package Type	
ZT3220LFEA	-40°C to +85°C	16-pin SSOP	(
ZT3220LFET	-40°C to +85°C	16-pin WSOIC	(
ZT3220LFEY	-40°C to +85°C	16-pin TSSOP	(
ZT3221LFEA	-40°C to +85°C	16-pin SSOP	(
ZT3221LFEY	-40°C to +85°C	16-pin TSSOP	(
ZT3222LFEA	-40°C to +85°C	20-pin SSOP	(
ZT3222LFET	-40°C to +85°C	18-pin WSOIC	(
ZT3222LFEY	-40°C to +85°C	20-pin TSSOP	(
ZT3223LFEA	-40°C to +85°C	20-pin SSOP	(
ZT3223LFEY	-40°C to +85°C	20-pin TSSOP	(
ZT3232LFEA	-40°C to +85°C	16-pin SSOP	(
ZT3232LFEN	-40°C to +85°C	16-pin nSOIC	(
ZT3232LFET	-40°C to +85°C	16-pin WSOIC	(
ZT3232LFEY	-40°C to +85°C	16-pin TSSOP	(
ZT3232LFEQ	-40°C to +85°C	16-pin QFN	(
ZT1385LFEA	-40°C to +85°C	20-pin SSOP	(
ZT1385LFET	-40°C to +85°C	18-pin WSOIC	(

Please contact the factory for pricing and availability on Tape-and-Reel options.



Zywyn Corporation

Headquarters and Sales Office

1270 Oakmead Parkway, Suite 201 • Sunnyvale, CA 94085 • Tel: (408) 733-3225 • Fax: (408) 733-3206 Email: sales@zywyn.com • www.zywyn.com

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